Keysight Technologies MXG X-Series Signal Generators N5181B Analog & N5182B Vector

9 kHz to 3 or 6 GHz

Data Sheet





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Pure and precise

On the path to better performance, the Keysight Technologies, Inc. MXG X-Series signal generators are fine-tuned to be your "golden transmitter" in R&D. Whether you're pushing for a linear RF chain or an optimized link budget, the analog and vector MXG models deliver what you need: phase noise, ACPR, channel coding, and more. Take your devices and designs to the limit with the MXG.

Definitions and Conditions

Specifications represent warranted performance of a calibrated instrument that has been stored for a minimum of 2 hours within the operating temperature range of 0 to 55 °C, unless otherwise stated, and after a 45 minute warm-up period. The specifications include measurement uncertainty. Data represented in this document are specifications unless otherwise noted.

Typical (typ) describes additional product performance information that is not covered by the product warranty. It is performance beyond specifications that 80 percent of the units exhibit with a 90 percent confidence level at room temperature (approximately 25 °C). Typical performance does not include measurement uncertainty.

Nominal (nom) values indicate the expected mean or average performance, or an attribute whose performance is by design, such as the 50 ohm connector. This data is not warranted and is measured at room temperature (approximately 25 °C).

Measured (meas) describes an attribute measured during the design phase for purposes of communicating expected performance, such as amplitude drift vs. time. This data is not warranted and is measured at room temperature (approximately 25 °C).

Frequency Specifications

on 503 on 506 11 Hz stable in nominal 0.1° increment	9 kHz (5 MHz I/Q mode) to 3 GHz 9 kHz (5 MHz I/Q mode) to 6 GHz s	
11 Hz	· · · · · · · · · · · · · · · · · · ·	
	S	
stable in nominal 0.1 ° increment	S	
d	Frequency range	N
	9 kHz to < 5 MHz	1 (digital synthesis)
	5 to < 250 MHz	1
	250 to < 375 MHz	0.25
	375 to < 750 MHz	0.5
	750 to < 1500 MHz	1
	1500 to < 3000.001 MHz	2
	3000.001 to 6000 MHz	4
		9 kHz to < 5 MHz 5 to < 250 MHz 250 to < 375 MHz 375 to < 750 MHz 750 to < 1500 MHz 1500 to < 3000.001 MHz

1. N is a factor used to help define certain specifications within the document.

Frequency switching speed 1,2				
	Standard	Option UNZ ³	Option UNZ, typical	
CW mode				
SCPI mode	≤ 5 ms, typical	≤ 1.15 ms	≤ 950 µs	
List/step sweep mode	≤ 5 ms, typical	≤ 900 µs	≤ 800 µs	
Digital modulation on (N5182	B only)			
SCPI mode	≤ 5 ms, typical	≤ 1.15 ms	≤ 1.05 ms	
List/step sweep mode	≤ 5 ms, typical	≤ 900 µs	≤ 800 µs	

- 1. Time from receipt of SCPI command or trigger signal to within 0.1 ppm of final frequency or within 100 Hz, whichever is greater.
- 2. With internal channel corrections on, the frequency switching speed is < 1.3 ms, measured for list mode and SCPI mode cached frequency points. For the initial frequency point in SCPI mode the time is < 3.3 ms, measured. The instrument will automatically cache the most recently used 1024 frequencies. There is no speed degradation for amplitude-only changes.
- 3. Specifications apply when status register updates are off. For export control purposes CW switching speed to within 0.05% of final frequency is 190 µs (measured).

Frequency reference				
Accuracy	± (time since last adjustment x aging rate) ± temperature effects ± line voltage effects ± calibration accuracy			
Internal time base reference oscillator aging rate ¹	$< \pm 1 \times 10^{-7}$ /year $< \pm 5 \times 10^{-10}$ /day after 30 days			
Initial achievable calibration accuracy	± 4 x 10 ⁻⁸ or ± 40 ppb			
Adjustment resolution	< 1 x 10 ⁻¹⁰			
Temperature effects	< ± 2 x 10 ⁻¹⁰ , nominal			
Line voltage effects	< ± 1 x 10 ⁻⁹ for ± 10% change, nominal			
Reference output				
Frequency	10 MHz			
Amplitude	≥ +4 dBm, nominal into 50 Ω load			
External reference input				
Input frequency, standard	10 MHz			
Input frequency, Option 1ER	1 to 50 MHz (in multiples of 0.1 Hz) ²			
Stability	Follows the stability of external reference input signal			
Lock range	± 1 ppm			
Amplitude	-3 dBm to +20 dBm, nominal			
Impedance	50 Ω, nominal			
Waveform	Sine or square			
Sweep modes (frequency and amplitude)				
Operating modes	Step sweep (equally spaced frequency and amplitude or logarithmically spaced frequency steps) List sweep (arbitrary list of frequency and amplitude steps) Simultaneously sweep waveforms with N5182B; see Baseband Generator section for more detail			
Sweep range	Within instrument frequency range			
Dwell time	100 μs to 100 s			
Number of points	2 to 65535 (step sweep) 1 to 3201 (list sweep)			
Step change	Linear or logarithmic			
Triggering	Free run, trigger key, external, timer, bus (GPIB, LAN, USB)			

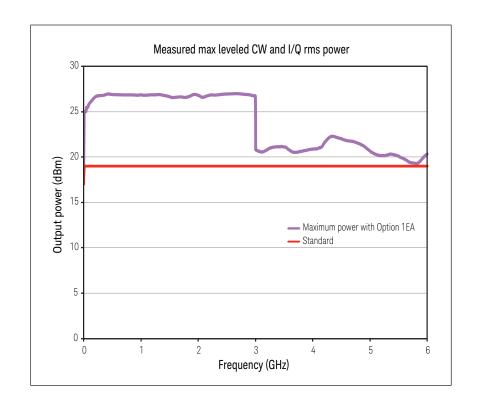
^{1.} Not verified by Keysight N7800A TME Calibration and Adjustments Software. Daily aging rate may be verified as a supplementary chargeable service, on request.

^{2.} Close-in phase noise will degrade when reference input is tuned away from 10 MHz.

Amplitude Specifications

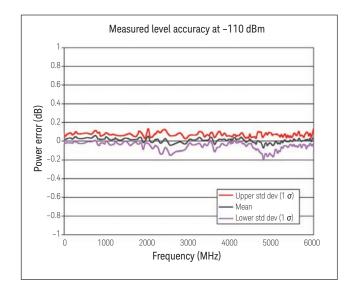
Output parameters			
Settable range	+30 to -144 dBm		
Resolution	0.01 dB		
Step attenuator	0 to 130 dB in 5 dB steps	s electronic type	
Connector	Type N 50 Ω, nominal		
Max output power ¹ () = typic	al		
Frequency	Standard	Option 1EA	
9 kHz to 10 MHz	+13 dBm	+17 dBm (+18 dBm)	
> 10 MHz to 3 GHz	+18 dBm	+24 dBm (+26 dBm)	
> 3 to 5 GHz	+16 dBm	+19 dBm (+20 dBm)	
> 5 to 6.0 GHz	+16 dBm	+18 dBm (+19 dBm)	

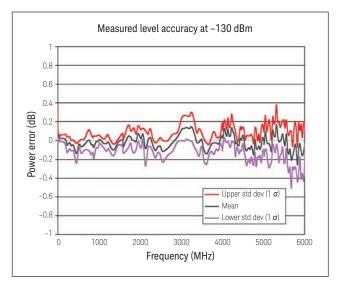
1. Quoted specifications between 20 °C and 30 °C. Maximum output power typically decreases by 0.01 dB/°C for temperatures outside this range.

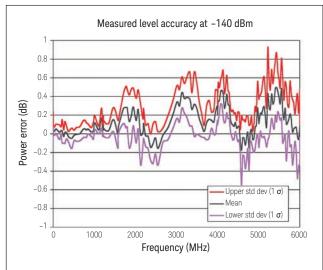


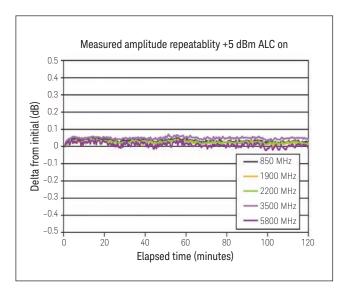
Absolute level accuracy in CW mode 1 (ALC on) ()= typical				
	Standard		Option 1EQ	
Range	Max power to -60 dBm	< -60 to -110 dBm	< -110 to -127 dBm	
9 to 100 kHz	(± 0.6 dB)	(± 0.9 dB)		
100 kHz to 5 MHz	± 0.8 dB (± 0.3)	± 0.9 dB (± 0.3)		
> 5 MHz to 3 GHz	± 0.6 dB (± 0.3)	± 0.8 dB (± 0.3)	± 1.5 dB (± 0.5)	
> 3 to 6 GHz	± 0.6 dB (± 0.3)	± 1.1 dB (± 0.3)	± 1.6 dB (± 0.6)	
Absolute level accuracy in CW m	ode (ALC off, power search run, re	lative to ALC on)		
9 kHz to 6 GHz	± 0.15 dB, typical			
Absolute level accuracy in digita	l I/Q mode (N5182B only)			
(ALC on, relative to CW, W-CDMA	1 DPCH configuration < +10 dBm)		
5 MHz to 6 GHz	± 0.25 dB, (0.05 dB)			

^{1.} Quoted specifications between 20 °C and 30 °C. For temperatures outside this range, absolute level accuracy degrades by 0.01 dB/°C. Output power may drift up to 0.10 dB < 3 GHz and 0.15 dB > 3 GHz per g/kg change in absolute humidity (nom).

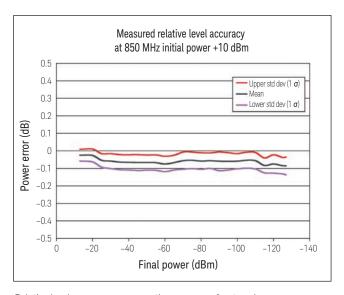




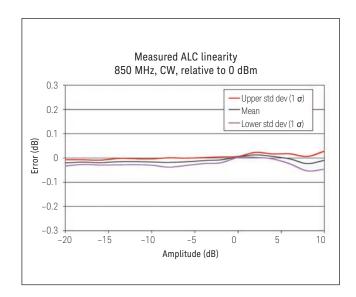


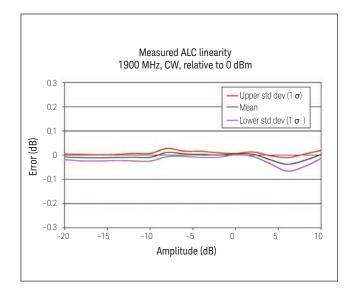


Repeatability measures the ability of the instrument to return to a given power setting after a random excursion to any other frequency and power setting. It should not be confused with absolute level accuracy.



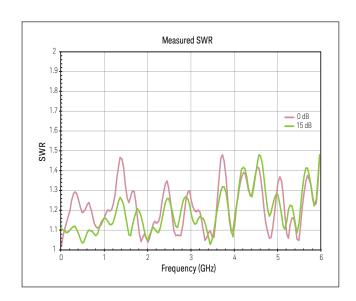
Relative level accuracy measures the accuracy of a step change from any power level to any other power level. This is useful for large changes (such as $5\ dB$ steps).

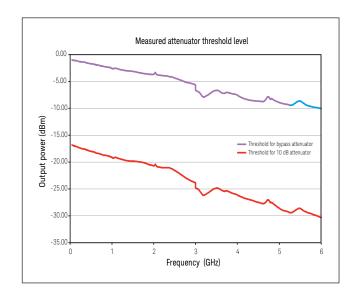




SWR (measured CW mode)1		
Frequency	Attenuator state		
	Bypass	0 to 10 dB	15 dB or more
≤ 1.0 GHz	< 1.3:1	< 1.35:1	< 1.2:1
> 1.0 to 2 GHz	< 1.55:1	< 1:5:1	< 1.3:1
> 2 to 3 GHz	< 1.8:1	< 1.5:1	< 1.45:1
> 3 to 4 GHz	< 1.5:1	< 1.6:1	< 1.7:1
> 4 to 6 GHz	< 1.9:1	< 1.6:1	< 1.6:1

1. SWR < 1.60:1 below 30 kHz.





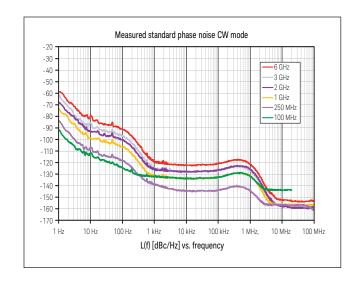
Maximum reverse power, nominal						
< 1 GHz	50 W					
> 1 to 2 GHz	25 W					
> 2 to 6 GHz	20 W					
Max DC voltage	50 VDC					
Trip level	2 W					
Amplitude switching speed 1	Standard	Option UNZ	Option UNZ, typical			
CW mode						
SCPI mode	≤ 5 ms, typical	≤ 750 µs	≤ 650 µs			
Power search SCPI mode	< 12 ms, measured					
List/step sweep mode	≤ 5 ms, typical	≤ 500 µs	≤ 300 µs			
Digital modulation on (N5182B only)						
SCPI mode	≤ 5 ms, typical	≤ 1.15 ms	≤ 950 µs			
Power search SCPI mode	< 12 ms, measured					
List/step sweep mode	≤ 5 ms, typical	≤ 900 µs	≤ 400 µs			
Alternate power level control (N518	32B only)					
Switching time (via waveform markers)	20 μs within ± 1 dB, measure	ed				
Functional power range	-15 dBm to -144 dBm, mea	sured				
User flatness correction						
Number of points	3201					
Number of tables	Dependent on available free	Dependent on available free memory in instrument; 10,000 maximum				
Entry modes	USB/LAN direct power meter meter control	er control, LAN to GPIB and USB to (GPIB, remote bus and manual USB/GPIB power			
Sweep modes						
	See Frequency Specification	ns section for more detail				

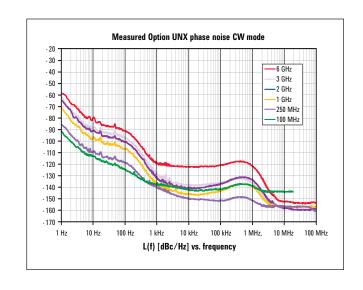
^{1.} Time from receipt of SCPI command or trigger signal to amplitude settled within 0.2 dB. Switching speed specifications apply when status register updates are off.

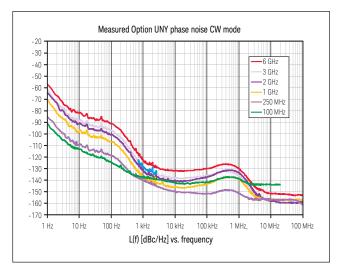
Spectral Purity Specifications

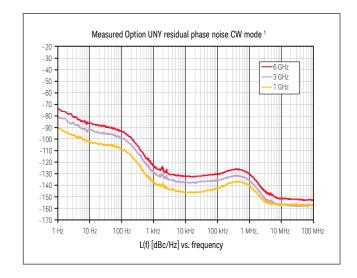
Standard absolute SSB phase noise (dBc/Hz, CW, at 20	kHz offset) () = typic	cal ¹		
5 MHz to < 250 MHz	-129 (-133)			
250 MHz	-140 (-143)			
500 MHz	-135 (-139)			
1 GHz	-131 (-134)			
2 GHz	-124 (-127)			
3 GHz	-123 (-127)			
4 GHz	-118 (-122)			
6 GHz	-116 (-121)			
Option UNX absolute SSB phase noise (dBc/Hz, CW, at 2	20 kHz offset) () = ty	pical ¹		
5 MHz to < 250 MHz	-140 (-143)			
250 MHz	-144 (-150)			
500 MHz	-143 (-150)			
1 GHz	-141 (-146)			
2 GHz	-135 (-141)			
3 GHz	-131 (-137)			
4 GHz	-118 (-122)			
6 GHz	-117 (-121)			
Option UNY absolute SSB phase noise (CW) () = measu	red ¹			
Frequency 1 Hz 10 Hz	100 Hz	1 kHz	10 kHz	100 kHz
100 MHz (-91) (-113)	(-124)	(–137)	(-142)	(-142)
249 MHz (-85) -93 (-110)	-103 (-118)	-130 (-137)	-139 (-142)	-138 (-142)
250 MHz (-85) -96 (-110)	-104 (-118)	-127 (-139)	-144 (-150)	-147 (-152)
500 MHz (-74) -89 (-100)	-98 (-109)	-125 (-139)	-139 (-149)	-145 (-149)
1 GHz (–70) –87 (–97)	-93 (-106)	-123 (-136)	-141 (-146)	-140 (-143)
2 GHz (-65) -79 (-90)	-85 (-101)	-114 (-131)	-135 (-140)	-134 (-137)
3 GHz (-61) -74 (-88)	-81 (-98)	-112 (-128)	-132 (-138)	-131 (-135)
4 GHz (-61) -73 (-84)	-79 (-95)	-110 (-124)	-130 (-134)	-127 (-131)
6 GHz (-57) -69 (-81)	-76 (-91)	-107 (-121)	-126 (-132)	-125 (-129)

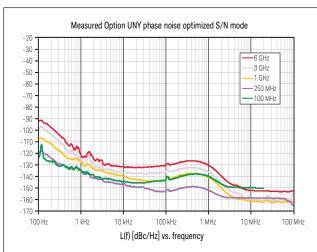
^{1.} From 20 to 30 °C, excludes mechanic vibration, measured @ +10 dBm or maximum specified power, whichever is less.

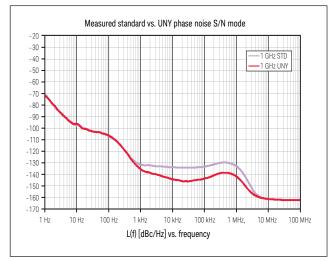


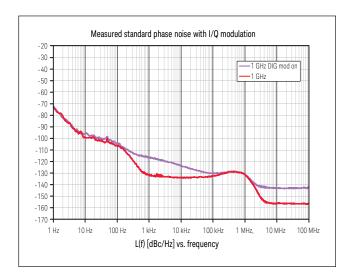


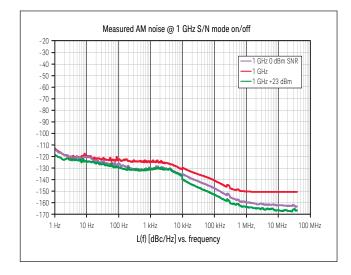












1. Use external 10 MHz input path, between +3 to +7 dBm for maximum performance.

Residual FM (CW mode, 300 Hz to	3 kHz BW, CCITT, rms)				
5 MHz to 6 GHz	< N x 2 Hz (measured) (se	ee N value in frequency ba	and table)		
Residual AM (CW mode, 0.3 to 3 kl	Hz BW, rms, +5 dBm)				
100 kHz to 3 GHz	< 0.01% (measured)				
Harmonics (CW mode)					
Range	Standard < +4 dBm		Option 1EA < +12 dBm		
9 kHz to 3 GHz	< -35 dBc		< -30 dBc		
> 3 to 4 GHz	< -35 dBc, typical		< -35 dBc, typical		
> 4 to 6 GHz	< -53 dBc, typical		< -40 dBc, typical		
Nonharmonics (CW mode) () = ty	pical				
Range	> 10 KHz offset				
	Standard (dBc)		UNX or UNY (dBc)		
9 kHz to < 5 MHz	-65, nominal		-65, nominal		
5 to < 250 MHz	-75		-75 (-80)		
250 to < 750 MHz	-87		-96 (-100)		
750 MHz to < 1.5 GHz	-87		-92 (-96)		
1.5 to < 3.0 GHz	-81		-86 (-90)		
3 to 6 GHz	-75		-80 (-84)		
Subharmonics (CW mode) () = typi	cal				
9 kHz to 1.5 GHz	None				
> 1.5 to 3 GHz	-77 dBc (-91)				
> 3 to 6 GHz	-74 dBc (-81)				
Jitter (standard phase noise) ²					
Carrier frequency	SONET/SDH data rate	rms jitter BW	μUI rms, typical	Seconds, typical	
155 MHz	155 MB/s	100 Hz to 1.5 MHz	91.8	0.6 ps	
622 MHz	622 MB/s	1 KHz to 5 MHz	50.5	81 fs	
2.488 GHz	2488 MB/s	5 kHz to 20 MHz	198	80 fs	
Jitter (UNX or UNY phase noise) ²					
Carrier frequency	SONET/SDH data rate	rms jitter BW	μUI rms, measured	Seconds, measured	
155 MHz	155 MB/s	100 Hz to 1.5 MHz	40	0.25 ps	
622 MHz	622 MB/s	1 KHz to 5 MHz	21	33 fs	
2.488 GHz	2488 MB/s	5 kHz to 20 MHz	72	29 fs	
Phase coherence (Option 012)					
LO input frequency range	250 MHz to 6 GHz, nomir	nal			
LO input power range	0 to +12 dBm, nominal				
LO output frequency range	250 MHz to 6 GHz, nomir	nal			
LO output power range	0 to +12 dBm, nominal				

< 3 GHz fixed 100 MHz spur is specified @ -78 dBc. In signal-to-noise optimization mode 100 MHz spur is < -100 dBc, measured. Calculated from phase noise performance in CW mode at +10 dBm. For other frequencies, data rates, or bandwidths, please consult your sales representative.

Analog Modulation Specifications

Frequency bands			
Band #	Frequency range	N	
1	9 kHz to < 5 MHz	(digital synthesis)	
1	5 to < 250 MHz	1	
2	250 to < 375 MHz	0.25	
3	375 to < 750 MHz	0.5	
4	750 to < 1500 MHz	1	
5	1500 to < 3000.001 MHz	2	
6	3000.001 to 6000 MHz	4	
Frequency modulation (Option UNT) (See N value above)		
Max deviation	N × 4 MHz, nominal³		
Resolution	1 Hz, nominal		
Deviation accuracy	< ± 2% + 20 Hz (1 kHz rate, deviation is N	x 50 kHz)	
Modulation frequency response	1 dB bandwidth	DC/5 Hz to 3 MHz, nominal	
@ 100 kHz deviation	3 dB bandwidth	DC/1 Hz to 7 MHz, nominal	
Carrier frequency accuracy	$< \pm 0.2\%$ of set deviation + $(N \times 1 \text{ Hz})^{1}$		
Relative to CW	$< \pm 0.06\%$ of set deviation + (N \times 1 Hz), ty	pical ²	
Total harmonic distortion	< 0.4% [1 kHz rate, deviation is N x 50 kHz	.]	
FM using external inputs 1 or 2	Sensitivity	+1 V peak for indicated deviation, nominal	
	Input impedance	50 $\Omega/600$ $\Omega/1$ M Ω , nominal	
	Paths FM path 1 and FM path 2 are summe composite modulation		
Phase modulation (Option UNT) (See I	V value above)		
Maximum deviation	Normal bandwidth	N × 2 radians, nominal	
	High-bandwidth mode	N × 0.2 radians, nominal	
Frequency response	Normal bandwidth (3 dB)	DC to 1 MHz, nominal	
	High-bandwidth mode (3 dB)	DC to 4 MHz, nominal	
Resolution	0.1% of deviation		
Deviation accuracy	< + 0.5% + 0.01 rad, typical [1 kHz rate, no	ormal bandwidth mode]	
Total harmonic distortion	< 0.2%, typical [1 kHz rate, N x 1 radian de	eviation normal bandwidth mode]	
ΦM using external inputs 1 or 2	Sensitivity	+1 V peak for indicated deviation, nominal	
	Input impedance	50 Ω or 600 Ω or 1 M Ω , nominal	
	Paths	Φ M path 1 and Φ M path 2 are summed internally for composite modulation	

Specification valid for temperature changes of less than ± 5 °C since last DCFM calibration.
 Typical performance immediately after a DCFM calibration.
 Digital synthesis band FM deviation is 5 MHz.

AM depth type	Linear or exp	Linear or exponential					
Maximum depth	100%						
Depth resolution	0.1% of depth	0.1% of depth (nom)					
AM depth error	f < 5 MHz		< 1.5% of set	ting + 1% (typ 0.5%	of setting + 1%)		
@1 KHz rate and < 80% depth	5 MHz < f < 2	GHz	< 3% of setti	ng + 1 %			
	2 < f < 3 GHz		< 5% of setti	ng + 1% (typical 3%	of setting + 1%)		
Total harmonic distortion @ 1 KHz rate	F < 5 MHz		30% depth 80% depth	< 0.25%, typ			
	5 MHz < f < 2	GHz	30% depth	< 2%			
	(2 to 3 GHz is		80% depth	< 2%			
Frequency response	30% depth, 3	B dB BW	DC/10 Hz to	50 KHz			
Frequency response wideband AM (N5182B only)	Rates ALC of	Rates ALC off/on: DC/800 Hz to 80 MHz, nominal					
AM inputs using external inputs 1 or 2	Sensitivity		+1 V peak for indicated de 2.2 V peak)		pth (Over-range can be 200% or		
	Input impedance 50 Ω or 600 Ω or 1M Ω , Damage level: \pm 5 V max						
	Paths	Paths AM path 1 and AM path 2 are summed internally for composite mode				posite modulation	
Wideband AM inputs	Sensitivity		0.5 V = 100%	6 (0.5 V DC offset re	quired)	·	
(N5182B only)	Input impeda	nce	50 Ω, nomina	al (Linput)			
Simultaneous and composite modu	ılation ²						
Simultaneous modulation	modulation o	annot be combine ource; for example	d and two modulation	types cannot be sinenerator, AM, and FN	multaneously enabled e multaneously generated M can run concurrently	using the same	
Composite modulation			of two modulation pat ation of internal or ext		ed internally for compos	site modulation;	
	AM	FM	Phase	Pulse	Internal I/Q 1	External I/Q 1	
AM	+	+	+	+	+	+	
FM	+	+	-	+	+	+	
Phase	+	-	+	+	+	+	
Pulse	+	+	+	-	+	+	
Internal I/Q (1)	+	+	+	+	-	+	
External I/Q (1)	+	+	+	+	+	_	

^{1.} AM specifications apply 6 dB below maximum specified power from 20 to 30 °C. 2. I/Q modulation available on N5182B.

(Option UNT required for FM, AM, and phase modu	lation inputs; Option UNW required for pulse modulation inputs)	
EXT1	AM, FM, PM	
EXT2	AM, FM, PM	
PULSE	Pulse (50 Ω only)	
I	Wideband AM (50 Ω only, N5182B only)	
Input impedance	50 Ω, 1 MΩ, 600 Ω, DC and AC coupled	
Standard internal analog modulation source		
(Single sine wave generator for use with AM, FM, _I	phase modulation requires Option UNT or 303)	
Waveform	Sine, square, triangle, positive ramp, negative ramp	
Rate range	0.1 Hz to 2 MHz (tunable to 3 MHz)	
Resolution	0.1 Hz	
Frequency accuracy	Same as RF reference source, nominal	
LF audio output	0 to 5 V peak into 50 Ω, –5V to 5 V offset, nominal	
Multifunction generator (Option 303)		
The multifunction generator option (Option 303) couly using the composite modulation features in	onsists of seven waveform generators that can be set independently with up to five simultane AM, FM/PM, and LF out	
Waveform		
Function generator 1	Sine, triangle, square, positive ramp, negative ramp, pulse	
Function generator 2	Sine, triangle, square, positive ramp, negative ramp, pulse	
Dual function generator	Sine, triangle, square, positive ramp, negative ramp, phase offset, and amplitude ratio for Tone 2 relative to Tone 1	
Swept function generator	Sine, triangle, square, positive ramp, negative ramp Trigger: free run, trigger key, bus, external, internal, timer trigger	
Noise generator 1	Uniform, Gaussian	
Noise generator 2	Uniform, Gaussian	
DC	Only for LF output –5 V to +5 V, nominal	
Frequency parameters		
Sine wave	0.1 Hz to 10 MHz	
Triangle, square, ramp, pulse	0.1 Hz to 1 MHz, nominal	
Noise bandwidth	10 MHz, nominal	
Resolution	0.1 Hz	
Frequency accuracy	Same as RF reference source, nominal	
Narrow pulse modulation (Option UNW) 1 () = typica	ıl	
On/off ratio	(> 80 dB)	
Rise/fall times (T _r , T _f)	< 10 ns; (7 ns)	
Minimum pulse width ALC on/off	> 2 μs/> 20 ns	
Repetition frequency ALC on/off	10 Hz to 500 kHz/DC to 10 MHz	
Level accuracy (relative to CW) ALC on/off ²	< ± 1.0 (± 0.5) dB/(< ± 0.5) dB	
Width compression (RF width relative to video out)	(< 5 ns)	

^{1.} Pulse specifications apply to frequencies > 100 MHz and power set to > -3 dBm. Operable down to 9 kHz. 2. With power search on.

Video feed-through¹ ≤ 3GHz/> 3 GHz	(< 50 mV/< 5mV)
External video delay (ext input to video)	30 ns, nominal
RF delay (video to RF output)	20 ns, nominal
Pulse overshoot	(< 15%)
Input level	+1 Vpeak = RF on into 50Ω , nominal
T _d video delay (variable) T _w video pulse width (variable)	

T_p pulse period (variable)

 T_m RF delay

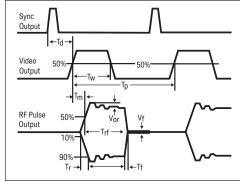
T_{rf} RF pulse width

 $T_f\,RF$ pulse fall time

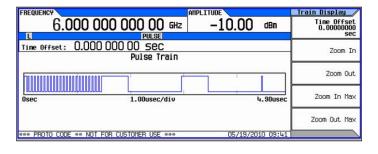
T_r RF pulse rise time

 V_{or} pulse overshoot

 V_f Video feedthrough



Internal pulse generator (included with Option UNW	1)	
Modes	Free-run, square, triggered, adjustable doublet, trigger doublet, gated, and external pulse	
Square wave rate	0.1 Hz to 10 MHz, 0.1 Hz	resolution, nominal
Pulse period	30 ns to 42 seconds, nor	minal
Pulse width	20 ns to pulse period –10	Ons, nominal
Resolution	10 ns	
Adjustable trigger delay	(- pulse period + 10 ns) t	to (pulse width -10 ns)
Settable delay	Free run	-3.99 to 3.97 μs
	Triggered	0 to 40 s
Resolution (delay, width, period)	10 ns, nominal	
Pulse doublets	1st pulse delay	(Relative to sync out) 0 to 42 s - pulse width - 10 ns
	1st pulse width	500 ns to 42 s - delay - 10 ns
	2nd pulse delay	0 to 42 s - (Delay 1 + Width 2) - 10 ns
	2nd pulse width	20 ns to 42 s - (Delay 1 + Delay 2) - 10 ns
Pulse train generator Option 320 (requires Option U	NW)	
Number of pulse patterns	2047	
On/off time range	20 ns to 42 sec	



^{1.} Video feed through applies to power levels < +10 dBm.

Avionics (Option 302)		
VOR		
Bearing accuracy		± 0.1 degrees
Frequency accuracy		Same as RF reference source, nominal
AM accuracy	30% depth	± 5% of setting
AM distortion		2%
FM accuracy	480 Hz deviation	± 1.7 Hz
ILS: localizer and glide slope		
AM accuracy	40% depth	± 5% of setting
AM distortion		2%
Difference in depth of modulation (DDM)	Localizer	0.0002
resolution	Glide slope	0.0004
Difference in depth of modulation (DDM)	Localizer	$\pm 0.0004 \pm 5\% \text{ of DDM}^1$
accuracy	Glide slope	± 0.0008 ± 5% of DDM ¹
Marker beacon		
Marker tone AM accuracy	95% depth	± 5% of setting + 1%
Marker tone AM distortion	95% depth	5%

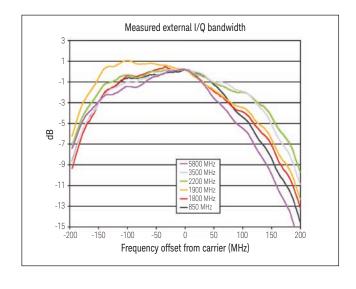
^{1.} DDM must not be equal to 0.

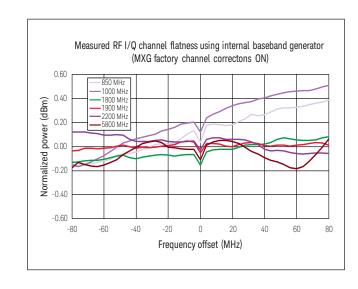
Vector Modulation Specifications

N5182B only

I/Q modulator external inputs ¹			
Bandwidth	Baseband (I or Q) RF (I+Q)	Up to 100 MHz baseband, nominal Up to 200 MHz RF, nominal	
I or Q offset	± 100 mV (200 uV resolution	on)	
I/Q gain balance	± 4 dB (0.001 dB resolutio	n)	
I/Q attenuation	0 to 50 dB (0.01 dB resolu	tion)	
Quadrature angle adjustment	± 200 units (0.1 units reso	ution)	
Full scale input drive (I+Q)	$0.5V$ into 50Ω , nominal		
Internal I/Q baseband generator adju	stments 1,2 (Options 656 and 657)		
I/Q offset	± 20% (0.025% resolution)		
I/Q gain	± 1 dB (0.001 dB resolutio	n)	
Quadrature angle adjustment	± 10 ° (0.01 degrees resolu	ution)	
I/Q phase	± 360.00 ° (0.01 degrees r	esolution)	
I/Q skew	± 800.00 ns (1 picosecond resolution)		
I/Q delay	± 250.00 ns (1 picosecond resolution)		
External I/Q outputs ¹			
Impedance	50 Ω, nominal per output		
	100 Ω, nominal differential output		
Туре	Single-ended or differentia	al (Option 1EL)	
Maximum voltage per output	1 V peak-to-peak or 0.5 V	1 V peak-to-peak or 0.5 V peak	
Bandwidth (I, Q)	Baseband (I or Q)	80 MHz, nominal (Option 656 and 657)	
	RF (I+Q)	160 MHz, nominal (Option 656 and 657)	
Amplitude flatness	± 0.2 dB measured with ch	± 0.2 dB measured with channel corrections optimized for I/Q output	
Phase flatness	± 2.5 degrees measured w	± 2.5 degrees measured with channel corrections optimized for I/Q output	
Common mode I/Q offset	± 1.5 V into 50 Ω (200 μV r	resolution)	
Differential mode I or Q offset	\pm 50 mV into 50 Ω (200 μ V resolution)		

- 1. I/Q adjustments represent user intverface nominal parameter ranges and not specifications.
- 2. Internal I/Q adjustments apply to RF out and I/Q outputs simultaneously.





Internal real-time complex digital I/Q filters (included with Option 656)

Factory channel correction (256 taps)

Corrects the linear phase and amplitude response of the baseband I/Q and RF outputs of the signal generator using factory calibration arrays. (default mode is off)

RF amplitude flatness (160 MHz)	± 0.2 dB measured
RF phase flatness (160 MHz)	± 2 degrees measured
User channel correction (256 tans)	

User channel correction (256 taps)

Automated routine uses power sensor to correct for linear phase and amplitude response of DUT (equalizer). See Users Guide for more details.

Recommended max amplitude error for	± 15 dB
correction	
Recommended max phase error for	± 25 degrees
correction	

Equalization filter (256 taps)

User can download and apply inverse or custom phase and amplitude response coefficients from tools such as MATLAB, 89600 VSA or SystemVue to correct for linear errors of DUT/system. See Users Guide for more details.

Baseband generator (Options 656 and 657)		
Channels	2 [I and Q]	
Resolution	16 bits [1/65,536]	
Sample rate	Option 656 Option 656 and 657	100 Sa/s to 100 MSa/s 100 Sa/s to 200 MSa/s
Maximum number of waveform files in cache	1024	
RF (I+Q) bandwidth	Option 656 Option 656 and 657	80 MHz, nominal 160 MHz, nominal
Interpolated DAC rate	800 MHz (waveforms only need OSR =	1.25)
Frequency offset range	± 80 MHz	
Digital sweep modes		st can have independent waveforms (N5182B) along with user see the Amplitude and Frequency Specifications sections for more
Waveform switching speed ¹	SCPI mode	≤ 5 ms, measured (standard)
		≤ 1.2 ms, measured (Option UNZ)
	List/step sweep mode	≤ 5 ms, measured (standard)
		≤ 900 µs, measured (Option UNZ)
Waveform transfer rates	FTP LAN to internal SSD	10.7 MB/sec or 2.67 Msa/sec
(measured, no markers, unencrypted)	Internal SSD to FTP LAN	7.7 MB/sec 1.92 Msa/sec
	FTP LAN to BBG	8.2 MB/sec or 2.05 Msa/sec
	FTP LAN to BBG encrypted	4 MB/sec or 1 Msa/sec
	USB to BBG	19 MB/sec or 4.75 Msa/sec
	BBG to USB	1.2 MB/sec or 300 Ksa/sec
	Internal SSD to BBG	48 MB/sec or 12 Msa/sec
	BBG to internal SSD	1.2 MB/sec or 300 Ksa/sec
	SD card to BBG (Option 006)	2.7 MB/sec or 678 Ksa/sec
	BBG to SD card (Option 006)	845 KB/sec or 211 Ksa/sec

^{1.} SCPI mode switching speed applies when waveforms are pre-loaded in list sweep and sample rate \geq 10 MSa/s.

Arbitrary waveform memory		32 Msa (standard)	
, ,	Maximum playback	512 Msa (Option 022	7)
	capacity	1024 Msa (Option 02	
	Maximum storage	3 GBytes/800 Msa (
	capacity including	30 GBytes/7.5 Gsa (
	markers	8 GBytes / 2 Gsa (Op	
Waveform segments		60 samples to 32 Ms	<u>' </u>
Taronomi oogimente	Segment length	60 samples to 512 Msa (Option 022)	
	oogotogt	60 samples to 1024	
	Minimum memory allocation per segment	256 samples	
	Maximum number of segments	8192	
	Label	Maximum number of	f waveform files
	Value	1024	
Waveform sequences	Maximum number of sequences	> 2000 depending o	n non-volatile memory usage
	Maximum number of	32,000 (standard)	
	segments/sequence	4 million (Option 022	2 or 023)
	Maximum number of repetitions	65,535	
Triggers	Types		Continuous, single, gated, segment advance
	Source		Trigger key, external, bus (GPIB, LAN, USB)
		Continuous	Free run, trigger and run, reset and run
	Mada	Single	No retrigger, buffered trigger, restart on trigger
	Modes	Gated	Negative polarity or positive polarity
		Segment advance	Single or continuous
	External coarse delay	time	5 ns to 40 s
	External coarse delay resolution		5 ns
	Trigger latency (Single trigger only)		356 ns + 1 sample clock period, nominal
	Trigger accuracy (Single trigger only)		± 2.5 ns, nominal
	Single trigger - restart on trigger mode will initiate a FIFO clear. Therefore, the latency includes re-fillin buffer. The latency is $8 \mu s + (1406 \times s)$ sample period) ± 1 sample clock period, nominal		, , , , , , , , , , , , , , , , , , , ,
Multi-baseband generator synchroniza-	Fan out		1 master and up to 15 slaves
tion mode	Trigger repeatability		< 1 ns, nominal
(multiple sources)	Trigger accuracy		Same as normal mode
	Trigger latency		Same as normal mode
	Fine trigger delay rang	е	See Internal I/Q Baseband section
	Fine trigger delay resolution		See Internal I/Q Baseband section
	I/Q phase adjustment	range	See Internal I/Q Baseband section

Markers	Markers are defined in a segment during the waveform generation process, or from the front panel; a marker can also be routed to the RF blanking, ALC hold functions, and alternate amplitude; see Users Guide for more information		
	Marker polarity	Negative, positive	
	Number of markers	4	
	RF blanking/burst on/off ratio	> 80 dB	
	Alternate amplitude control switching speed	See amplitude section	
Real-time modulation FIR filter:	Filter Types: Nyquist, root-Nyquist, WCDMA, EDGE, Gaussian, rectangular, APCO 25 C4FM, IS-95, User FIR (Applies real-time FIR filtering when playing waveforms with OSR=1. Helps reduce waveform size for long simulation times. Option 660 not required.)		
Real-time baseband generator (Optio	· · · · · · · · · · · · · · · · · · ·		
Real-time baseband generator required for real-time Signal Studio	Cellular real-time applications	LTE-FDD, LTE-TDD, HSPA+/W-CDMA, GSM/EDGE, cdma2000®	
applications 1	Real-time navigation	GPS, GLONASS, Galileo	
	Real-time video applications	DVB-T/T2/H/S/S2/C/J.83 Annex A/C, ISDB-T/	
	Note: Option 660 is not required for real-time custom modulation (Option 431)		
	Memory: Shares memory with Options 656 and 657		
	Triggering: Same as Options 656 and 657		
	Markers: 3 markers available, all other features are same as Options 656 and 657		
Digital baseband inputs/outputs (Opt	ion 003/004)		

Options 003 and 004 activate the rear panel digital I/Q bus and enable connectivity to the N5102A digital signal interface module. In output mode (003), you can deliver realistic complex-modulated signals such as LTE, GPS, WLAN, custom pulses and many others directly to your digital devices and subsystems. In the input mode (004), the interface module ports your digital input to the signal generator's baseband system, providing a quick and easy way of upconverting to calibrated analog I/Q, IF, or RF frequencies. In both operating modes, the interface module adapts to your device with the logic type, data format, clock features, and signaling you require.

Data (requires N5102A)		
Digital data format	User-selectable: 2's complement or binary offset, I/Q (I, I-bar, Q, Q-bar) or digital IF output (real, imaginary)	
Data port	Dual 16-bit data buses support parallel, parallel I/Q interleaved, parallel Q/I interleaved, or serial port configuration	
N5102A connectors (breakout boards)	144-pin Tyco Z-Dok+ connects to break-out boards (included with N5102A) that interface with the following connector types: 68-pin SCSI, 38-pin dual AMP Mictor, 100-pin dual Samtec, 20-pin dual 0.1 inch headers, 40-pin dual 0.1 inch headers	
Logic types	Single-ended: LVTTL, 1.5V CMOS, 1.8V CMOS, 2.5V CMOS, 3.3.V CMOS	
	Differential: LVDS	
Data output resampling	MXG baseband output is resampled to the arbitrary clock rate set by the user via real-time curve-fit calculations.	

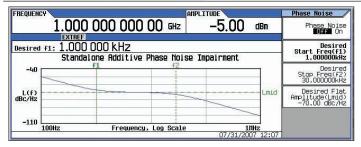
^{1.} See www.keysight.com/find/signalstudio for more information.

Clock (requires N5102A)			
Clock input	User selectable: internal clock, device under test clock, or external clock (via SMA or breakout board)		
	N5102A SMA Ext Clock In connector: 50 Ω, 0 dBm i	nominal, 1 to 400 MHz	
Clock output	User selectable: via breakout board or SMA Clock Out connector		
	N5102A SMA Clock Out connector: 2 Vpp into load > 5K Ω from 1 to 100 kHz, 400 mVpp into 50 Ω load from 100 kHz to 400 MHz		
Sample rate (limited by MXG sample rate)	User-selectable in parallel mode up to a maximum 2 users guide for more details). User-selectable in serial mode, the maximum rate is		
Bit rate (limited by MXG sample rate)	Parallel Up to 200 MHz x word size (1.6 Gbps LVDS, CMOS and LVTTL) per parallel bus, 2 parallel buses available		
	Serial Up to 400 MHz per serial line (400 Mbps LVD lines available	S) or 150 MHz per serial line (150 Mbps (CMOS/LVTTL) 32	
Clocks per sample	In parallel output mode, the data sample can be hel	d for 1, 2 or 4 clock cycles	
Clock to data skew	Coarse adjustment in 90° steps from 0 to 270°; fine		
Clock polarity	Clock signals may be inverted		
Frequency reference input	1 to 100 MHz BNC, 50 Ω, 3 dBm ± 6 dB		
Power supply (included on N5102A)	Output: 5V, 4A DC		
AWGN (Option 403)			
Туре	Real-time, continuously calculated, and played usin	na DSP	
Modes of operation	Standalone or digitally added to signal played by arl	<u> </u>	
Bandwidth	With Option 656	1 Hz to 80 MHz	
Sandwidth	With Option 656 and 657	1 Hz to 160 MHz	
Crest factor	15 dB	1112 (0 100 1111)2	
Randomness	90 bit pseudo-random generation, repetition period	1.313 x 10 ⁹ years	
Carrier-to-noise ratio	± 100 dB when added to signal	Jelex to your	
Carrier-to-noise ratio formats	C/N, Eb/No		
Carrier-to-noise ratio error	Magnitude error ≤ 0.2 dB at baseband I/Q outputs		
Custom modulation Arb Mode (Option			
Modulation	PSK	BPSK, QPSK, OQPSK, π/4DQPSK, gray coded and unbalanced QPSK, 8PSK, 16PSK, D8PSK, IS95 QPSK, IS95 OQPSK, EDGE, HDQPSK, SOQPSK	
	QAM	4, 16, 32, 64, 128, 256, 1024 (and 89600 VSA mappings	
	FSK	Selectable: 2,4,8, 16, C4FM, HCPM	
	MSK	0 to 100 °	
	ASK	0 to 100%	
	DVB-S2 APSK	16APSK 2/3, 16APSK 3/4 16APSK 4/5, 16APSK 5/6, 16APSK 8/9, 16APSK 9/10, 32APSK 3/4 32APSK 4/5, 32APSK 5/6, 32APSK 8/9, 32APSK 9/10	
Multicarrier	Number of carriers	Up to 100 (limited by a max bandwidth of 160 MHz depending on symbol rate and modulation type)	
	Frequency offset (per carrier)	Up to -80 to +80 MHz	
	Power offset (per carrier)	0 dB to -40 dB	
Symbol rate	50 sps to 100 Msps		
Filter types	Nyquist, root-Nyquist, Gaussian, rectangular, APCO 25 C4FM, user	IS-95 w/EQ, IS-95 Mod, IS-95 Mod w/EQ, HDQPSK, APCO25 HCPM, SOQPSK-TG	
Quick setup modes	APCO 25w/C4FM, APCO25 w/CQPSK, Bluetooth®, CDPD, DECT, EDGE, GSM, NADC, PDC, PHS, PWT, TETRA	16APSK 2/3, 16APSK 3/4 16APSK 4/5, 16APSK 5/6, 16APSK 8/9, 16APSK 9/10, 32APSK 3/4, 32APSK 4/5, 32APSK 5/6, 32APSK 8/9, 32APSK 9/10, SOQPSK	
Data	Random only	· · ·	

Modulation	PSK		BPSK, QPSK, OQPSK, π/4DQPSK, gra coded and unbalanced QPSK, 8PSK, 16PSK, D8PSK	
	QAM		4, 16, 32, 64, 128, 256, 1024 (and 89600 VSA mappings)	
		Selectable	2,4,8, 16 level symmetric, C4FM	
	FSK	User-defined	Custom map of up to 16 deviation levels	
		Max deviation	20 MHz	
	MSK	0 to 100 °		
	ASK	0 to 100%		
	Custom I/Q	Custom map of 1024 unique valu	ues	
Frequency offset	Up to -80 MHz to +80 MHz			
Symbol rate	Internal generated data	1 sps up to 100 Msps and max o	f 10 bits per symbol	
	External serial data	1 sps to [(50 Mbits/sec)/(#bits/symbol)]		
Filter types	Selectable	Nyquist, root-Nyquist, Gaussian, rectangular, APCO 25 (phase 1 and 2 DL), IS-95, WCDMA,EDGE (wide and HSR)		
	Custom FIR	coefficients (max) > 32 to 64 symbol filter: symbol > 16 to 32 symbol filter: symbol		
Quick setup modes	APCO 25 with (C4FM, CQPS PHS, PWT, WorldSpace, Irid		oth, CDPD, DECT, EDGE, GSM, NADC, PDC,	
Trigger delay	Range		0 to 1,048,575 bits	
	Resolution		1 bit	
Data types		Pseudo-random patterns	PN9, PN11, PN15, PN20, PN23	
	Internally generated	Repeating sequence	Any 4-bit sequence	
			32 Mb (standard)	
	·	Direct-pattern RAM [PRAM] max size Note: Used for custom TDMA/non-standard framing		
	Note. Osed for custoffi foly	iA/non-standard framing	1024 Mb (Option 023)	
			32 MB (standard)	
	User file	User file		
			1024 MB (Option 023)	
	Externally streamed data	Туре	Serial data	
	(via AUX I/O)	Inputs/outputs ¹	Data, symbol sync, bit clock	
Internal burst shape	Rise/fall time range	<u>. </u>	Up to 30 bits	
(varies with bit rate)		Rise/fall delay range		

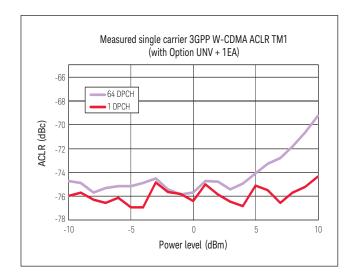
^{1.} Bit clock and symbol sync inputs will be available in future firmware release.

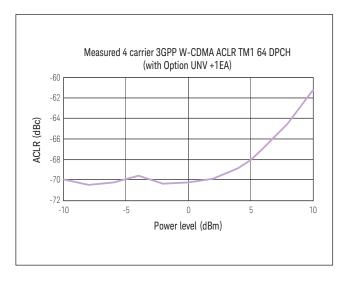
Multitone and two-tone (Option 430)						
Number of tones	2 to 512, with selectable on	2 to 512, with selectable on/off state per tone				
Frequency spacing	100 Hz to 160 MHz (Option	100 Hz to 160 MHz (Option 656 and 657)				
Phase (per tone)	Fixed or random					
Real-time phase noise impairments (Op	otion 432)					
Close-in phase noise characteristics	-20 dB per decade					
Far-out phase noise characteristics	-20 dB per decade					
Mid-frequency characteristics	Start frequency (f1)	Offset settable from 0 to 77 MHz				
	Stop frequency (f2)	Offset settable from 0 to 77 MHz				
Phase noise amplitude level (L(f))	User selected; max degradation dependent on f2					



3GPP W-CDMA dist	ortion performance 1,2							
			Standard		Option UN	V	Option UN with Option	
Power level			≤ 2 dBm ²		≤ 2 dBm ²		≤ 5 dBm ²	
Offset	Configuration	Frequency	Spec	Тур	Spec	Тур	Spec	Тур
Adjacent (5 MHz)	1 DDOLL 1 corrier	1000 to 2000 MHz	- 69 dBc	-73 dBc	-71 dBc	-75 dBc	-71 dBc	-75 dBc
Alternate (10 MHz)	1 DPCH, 1 carrier	1800 to 2200 MHz	-70 dBc	-75 dBc	-72 dBc	-77 dBc	-71 dBc	-77 dBc
Adjacent (5 MHz)	Test model 1 with	1800 to 2200 MHz	-68 dBc	-70 dBc	-71 dBc	-73 dBc	-71 dBc	-72 dBc
Alternate (10 MHz)	64 DPCH, 1 carrier	1000 to 2200 MHZ		-73 dBc	-72 dBc	-76 dBc	-71 dBc	-76 dBc
Adjacent (5 MHz)	Test model 1 with	1800 to 2200 MHz	-63 dBc	-65 dBc	-65 dBc	-67 dBc	-64 dBc	-66 dBc
Alternate (10 MHz)	64 DPCH, 4 carrier	1000 to 2200 MHZ	-64 dBc	-66 dBc	-66 dBc	-68 dBc	-66 dBc	-68 dBc

ACPR specifications apply when the instrument is maintained within 20 to 30 $^{\circ}$ C. This is rms power. Convert from rms to peak envelope power (PEP) with the following equation: PEP = rms power + crest factor (for example, 3GPP test model 1 with 64 DPCH has a crest factor 11.5 dB, therefore at +5 dBm rms, the PEP = 5 dBm + 11.5dB = +16.5 dBm PEP).





3GPP LTE-FDD distortion performance ¹								
			Standard		Option UN\	I	Option UN\ with Option	
Power level			≤ 2 dBm ²		≤ 2 dBm ²		≤ 5 dBm ²	
Offset	Configuration	Frequency	Spec	Тур	Spec	Тур	Spec	Тур
Adjacent (10 MHz) ³	10 MHz E-TM 1.1	1000 to 2200 MHz	-64 dBc	-66 dBc	-67 dBc	-69 dBc	-64 dBc	-67 dBc
Alternate (20 MHz) ³	QPSK	1800 to 2200 MHz	-66 dBc	-68 dBc	-69 dBc	-71 dBc	-69 dBc	-71 dBc

- 1. ACPR specifications apply when the instrument is maintained within 20 to 30 °C.
- 2. This is rms power. Convert from rms to peak envelope power with the following equation: PEP = rms power + crest factor (for example, 3GPP test model 1 with 64 DPCH has a crest factor 11.5 dB, therefore at +5 dBm rms, the PEP = 5 dBm + 11.5 dB = +16.5 dBm PEP).
- 3. ACPR measurement configuration: reference channel integration BW: 9.015 MHz, offset channel integration bandwidth: 9.015 MHz.



GSM/EDGE output I	RF spectrum (ORFS)					
			GSM		EDGE	
Power level			< +7 dBm		< +7 dBm	
Offset	Configuration	Frequency ¹	Standard, typical	Option UNV, typical	Standard, typical	Option UNV, typical
200 kHz			-34 dBc	-36 dBc	-37 dBc	-38 dBc
400 kHz		000 : 000 \	-69 dBc	-70 dBc	-69 dBc	-70 dBc
600 kHz	1 normal timeslot,bursted	800 to 900 MHz 1800 to 1900 MHz	-81 dBc	-82 dBc	-80 dBc	-81 dBc
800 kHz	Dursten	1000 to 1300 WILIZ	-82 dBc	-83 dBc	-82 dBc	-83 dBc
1200 kHz			-84 dBc	-85 dBc	-83 dBc	-84 dBc
3GPP2 cdma2000 c	listortion performance	e, typical				
			Standard	Option UNV	Option UNV + 1EA	
Power level ²			≤ 2dBm	≤ 2 dBm	≤ 5 dBm	
Offset	Configuration	Frequency (1)	Typical	Typical	Typical	
885 kHz to 1.98 MHz			-78 dBc	-79 dBc	-77 dBc	
> 1.98 to 4.0 MHz	9 channel forward link	800 to 900 MHz	-86 dBc	-87 dBc	-87 dBc	
> 4.0 to 10 MHz			-91dBc	-93 dBc	-93 dBc	
802.16e Mobile WiMA	X™ distortion performa	nce, measured				
Power	Offset ³	Configuration 4	Frequency	Standard, measured	UNV, measured	
< -7 dBm	10 MHz	QPSK	2.5 and 3.5 GHz	-65 dBc	-68 dBc	
Up to +5 dBm	10 MHz	QPSK	3.5 GHz	-62 dBc	-65 dBc	
			·			

Performance evaluated at bottom, middle, and top of bands shown.

This is rms power. Convert from rms to peak envelope power (PEP) with the following equation: PEP = rms power + crest factor (for example: 3GPP test model 1 with 64 DPCH has a crest factor > 11 dB, therefore at +5 dBm rms the PEP = 5 dBm + 11 dB = +16 dBm PEP).

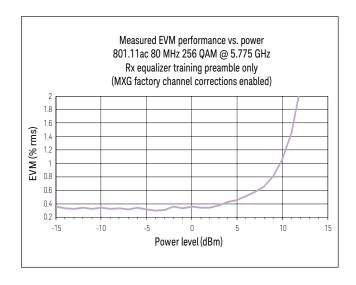
Measurement configuration: reference channel integration BW: 9.5 MHz, offset channel integration BW: 9 MHz, channel offset: 10 MHz.

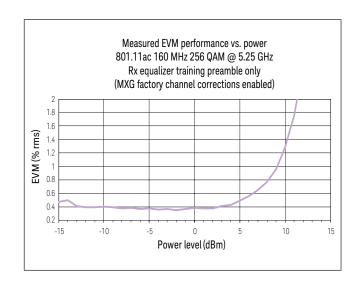
802.16e WiMAX signal configuration—bandwidth: 10 MHz, FFT: 1024, frame length: 5 ms, guard period: 1/8, symbol rolloff: 5%, content: 30 symbols of

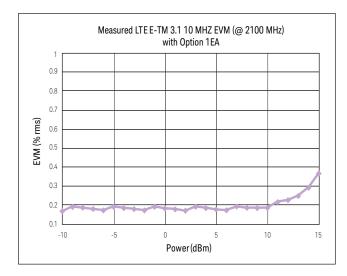
PN9 data.

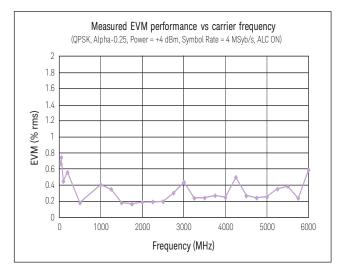
EVM performance	data 1, 2										
Format	GSM		EDGE		cdma200	cdma2000/IS95A		١	LTE FDD ³		
Modulation type	GMSK (burs	ted)	3pi/8 8PS	3pi/8 8PSK (bursted)		QPSK		QPSK		64 QAM	
Modulation rate	270.833 ksp	OS	70.833 ks	sps	1.2288 M	lcps	3.84 Mcp)S	10 MHz B	W	
Configuration	1 timeslot		1 timeslo	t	Pilot cha	nnel	1 DPCH		E-TM 3.1		
Frequency ⁴	800 to 900 1800 to190		800 to 90 1800 to 1		800 to 90 1800 to 1	00 MHz 1900 MHz	1800 to 2	2200 MHz	1800 to 2	200 MHz	
EVM power level	≤ 7 dBm		≤7 dBm		≤ 7 dBm		≤7 dBm		≤ 7 dBm		
EVM power level with Option 1EA	≤ 13 dBm				≤ 13 dBm	1	≤ 13 dBm	1	≤ 13 dBm		
EVM/global phase error	Spec	Тур	Spec	Тур	Spec	Тур	Spec	Тур	Measure	d	
	rms 0.8 °	0.2 °	1.2%	0.75%	1.3%	0.8%	1.2%	0.8%	0.2%		
Format	802.11a/g	802.11ac ⁵	QPSK				16 QAM				
Modulation type	64 QAM	256 QAM	QPSK			16 QAM					
Modulation rate	54 Mbps	80 MHz	4 Msps (re	oot-Nyquist fi	$lter \alpha = 0.25)$						
Frequency ⁴	2400 to 2484 MHz	5.775 GHz	≤ 3 GHz ≤ 6 GHz		≤ 3 GHz		4 6 CH7				
	5150 to 5825 MHz				≤ 0 GHZ	≤ b GHZ			≤ 6 GHz		
EVM power level	≤ -5 dBm	≤ -5 dBm	≤ 4 dBm		≤ 4 dBm		≤ 4 dBm		≤ 4 dBm		
EVM power level with Option 1EA	≤ 2 dBm	≤ 2 dBm	≤ 10 dBm		≤ 10 dBm	1	≤ 10 dBm	1	≤ 10 dBm		
EVM	Measured	Measured	Spec	Тур	Spec	Тур	Spec	Тур	Spec	Тур	
	0.3%	0.4%	1.2%	0.8%	1.9%	1.1%	1.1%	0.65%	1.5%	0.9%	

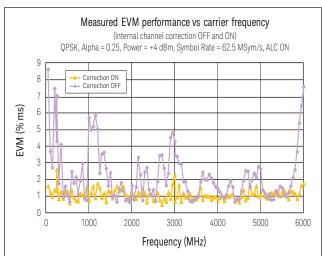
- EVM specifications apply for the default ARB file setup conditions with the default ARB files supplied with the instrument. EVM specifications apply after execution of I/Q calibration when the instrument is maintained within \pm 5 °C of the calibration temperature.
- LTE FDD E-TM 3.1,10 MHz, 64 QAM PDSCH, full resource block. Measured EVM after DC calibration.
- Performance evaluated at bottom, middle, and top of bands shown.
- WLAN 802.11ac 80 MHz, 256 QAM, MCS 8, 7 symbols, no filtering. Channel corrections enabled. Rx equalizer training preamble only.

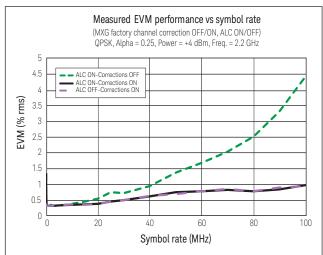












Bit error rate [BER] analyzer (Option UN7)			
Clock rate	100 Hz to 60 MHz (usable to 90 MHz)		
Data patterns	PN9, 11, 15, 20, 23		
Resolution	10 digits		
Bit sequence length	100 bits to 4,294 Gbits after synchronization		
Other features	Input clock phase adjustment and gate delay		
	Direct measurement triggering		
	Data and reference signal outputs		
	Real-time display		
	Bit count		
	Error-bit-count		
	Bit error rate		
	Pass/fail indication		
	Valid data and clock detection		
	Automatic re-synchronization		
	Special pattern ignore		

General Specifications

Remote programming	
Interfaces	GPIB IEEE-488.2, 1987 with listen and talk
	LAN 1000BaseT LAN interface, LXI class C compliant
	USB Version 2.0
Control languages	Control languages SCPI Version 1997.0
Compatibility languages	Keysight Technologies: N5181A\61A, N 5182A\62A, N5183A, E4438C, E4428C, E442xB, E443xB, E8241A, E8244A, E8251A, E8254A, E8247C, E8257C/D, E8267C/D, 8648 Series, 8656B, E8663B, 8657A/B, 8662A, 8663A
	Aeroflex Incorporated: 3410 Series
	Rohde & Schwarz: SMB100A, SMBV100A, SMU200A, SMJ100A, SMATE200A, SMIQ, SML, SMV
Power requirements	
100-120 VAC, 50/60/400 Hz	
220-240 VAC, 50/60 Hz	
160 W maximum (N5181B)	
300 W maximum (N5182B)	
Operating temperature range	
0 to 55 °C	
Storage temperature range	
−40 to 70 °C	
Operating and storage altitude	
Up to 15,000 feet	
Humidity	
Relative humidity - type tested at 95%,	+40 °C (non-condensing)
Environmental stress	

Samples of this product have been type tested in accordance with the Keysight Environmental Test Manual and verified to be robust against the environmental stresses of storage, transportation and end-use; those stresses include but are not limited to temperature, humidity, shock, vibration, altitude, and power line conditions; test methods are aligned with IEC 60068-2 and levels are similar to MIL-PRF-28800F Class 3

Safety Complies with European Low Voltage Directive 2006/95/EC - IEC/EN 61010-1, 2nd Edition Acoustic noise emission Geraeuschemission Canada: CSA C22.2 No. 61010-1 LpA < 70 dB LpA < 70 dB - USA: UL std no. 61010-1, 2nd Edition Operator position Am Arbeitsplatz - German Acoustic statement Normal position Normaler Betrieb Per ISO 7779 Nach DIN 45635 t.19 Complies with European EMC Directive 2004/108/EC - IEC/EN 61326-1or IEC/EN 61326-2-1 This ISM device complies with Canadian ICES-001; - CISPR Pub 11 Group 1, class A cet appareil ISM est conforme a la norme NMB-001 du Canada - AS/NZS CISPR 11 - ICES/NMB-001

Memory

- Memory is shared by instrument states, user data files, sweep list files, waveform sequences, and other files
- 3 GB (30 GB with Option 009) memory available in the N5182B
- Security Option 006 allows storage of up to 8 GB on SD card
- Depending on how the memory is utilized, a maximum of 1000 instrument states can be saved

Security (Option 006)

- Removable 8 GB solid state memory (SD card) from rear panel
- User can force all files to be stored only on external memory card including instrument states, user data files, sweep list files, waveforms, waveform sequences, and other files.
- Memory sanitizing, memory sanitizing on, power on, and display blanking
- Note: Read/write speeds to external memory card will be slower compared to internal solid-state drive (Option 009)

Self-test

Internal diagnostic routines test most modules in a preset condition; for each module, if its node voltages are within acceptable limits, the module passes the test

Weight

N5181B: \leq 13.6 kg (30 lb) net, \leq 28.6 kg (63 lb) shipping N5182B: \leq 15.9 kg (35 lb) net, \leq 30.8 kg (68 lb) shipping

Dimensions

88 mm H x 426 mm W x 489 mm L (length includes rear panel feet)

(3.5 in H x 16.8 in W x 19.2 in L)

Max length (L) including RF connector tip to end of rear panel feet is 508 mm (20 in)

Recommended calibration cycle

36 months

ISO compliant

This instrument is manufactured in an ISO-9001 registered facility in concurrence with Keysight Technologies' commitment to quality.

Inputs and Outputs

Front panel connectors				
RF output	Outputs the RF signal via a precision N type female connector; see output section for reverse power protection information			
I and Q inputs	BNC input accepts "in-phase" and "quadrature" input signals for I/Q modulation; nominal input impedance is 50Ω , damage levels are 1 Vrms and 5 Vpeak			
USB 2.0	Used with a memory stick for transferring instrument states, licenses and other files into or out of the instrument; also used with U2000, U848X and U202X Series USB power sensors.			
Rear panel connectors				
Rear panel inputs and outputs are 3.3 V	CMOS, unless indicated otherwise; CMOS inputs will accept 5 V CMOS, 3 V CMOS, or TTL voltage levels			
RF output (Option 1EM)	Outputs the RF signal via a precision N type female connector			
I and Q inputs (Option 1EM)	Accepts "in-phase" and "quadrature" input signals for I/Q modulation SMB connector, nominal input impedance is $50~\Omega$; damage levels are 1 Vrms and 5 Vpeak; Option 1EM units will come with 2 SMB to BNC adapters			
I and Q outputs	BNC outputs the analog I/Q modulation signals from the internal baseband generator; nominal output impedance 50 Ω , DC coupled; damage levels \pm 2 V			
I bar and Q bar outputs (Option 1EL)	BNC outputs the complement of the I and Q signals for differential applications;			
Event 1	This connector outputs the programmable timing signal generated by marker 1 The marker signal can also be routed internally to control the RF blanking and ALC hold functions; this signal is also available on the AUX I/O connector With bit error rate analyzer (Option UN7) this connector is used for data input Damage levels are > +8 V and < -4 V			

Pattern trigger	Accepts signal to trigger internal pattern generator to start single pattern output, for use with the internal baseband generators Accepts CMOS signal with minimum pulse width of 10 ns Female BNC Damage levels are > +8 V and < -4 V			
BBTRIG 1	For arbitrary and real-time baseband generators I/O such as Markers or trigger inputs With bit error rate analyzer (Option UN7) this connector is used for clock input			
BBTRIG 2	For arbitrary and real-time baseband generators I/O such as Markers or trigger inputs With bit error rate analyzer (Option UN7) this connector is used for gate input			
Sweep out	Generates output voltage, 0 to +10 V when the signal generator is sweeping; this output can also be programmed to indicate when the source is settled or output pulse video and is TTL and CMOS compatible in this mode; output impedance < 1 Ω , can drive 2 k Ω ; damage levels are \pm 15 V			
Ext 1	External AM/FM/PM #1 input; nominal input impedance is 50 Ω /600 Ω /1M Ω , nominal; damage levels are ± 5 V			
Ext 2	External AM/FM/PM #2 input; nominal input impedance is 50 Ω /600 Ω /1M Ω , nominal; damage lev are ± 5 V			
LF OUT	0 to 5 V peak into 50 Ω, -5 V to 5 V offset, nominal			
Pulse	External pulse modulation input; this input is TTL and CMOS compatible; low logic levels are 0 V and high logic levels are \pm 1 V; nominal input impedance is 50 \pm 1; input damage levels are \pm 0.3 V and \pm \pm 1.3 V			
Trigger in	Accepts TTL and CMOS level signals for triggering point-to-point in sweep mode; damage levels are \leq -0.3 V and \geq +5.3 V			
Trigger out	Outputs a TTL and CMOS compatible level signal for use with sweep mode The signal is high at start of dwell, or when waiting for point trigger in manual sweep mode, and low when dwell is over or point trigger is received This output can also be programmed to indicate when the source is settled, pulse synchronization, or pulse video Nominal output impedance 50Ω Input damage levels are $\le -0.3 \text{ V}$ and $\ge +5.3 \text{ V}$			
Reference input	Accepts a 10 MHz reference signal used to frequency lock the internal timebase; Option 1ER adds the capability to lock to a frequency from 1 MHz to 50 MHz; nominal input level –3 to +20 dBm, impedance 50 Ω, sine or square waveform			
10 MHz out	Outputs the 10 MHz reference signal used by internal timebase; level nominally +3.9 dBm; nominal output impedance 50 Ω; input damage level is +16 dBm			
LO in (Option 012)	Accepts a signal from a master signal generator that is used as the LO for MXG vector in order to configure a phase coherent system; nominal input levels between 0 to +12 dBm; nominal input impedance $50~\Omega$			
LO out (Option 012)	Outputs a reference signal that can be used in a phase coherent system; nominal output levels between 0 to +12 dBm; nominal output impedance 50 Ω			
DAC Clk In (Option 012)	Reserved for future use.			
Digital bus I/O	To be used with PXB or N5102A digital signal interface module			

Aux I/O	Aux I/O port sends and/or receives auxiliary signaling information: For Option UN7 this connector is used to output reference data, clock, error signals, and more Output markers to an external device from arbitrary waveform or real-time generation application such as: frame markers, pulse-per-second, even-second, and more. Input signals from external DUT to modify characteristics of a signal being generated such as changing output power (power control loop testing), advancing or delaying timing (timing advance loop testing), HARQ ACK/NAK delivery (HARQ process loop testing) or streaming external data, clock and symbol synch for custom modulation. I/O is application specific (CDMA, 3GPP, GNSS, LTE, custom). See User Guide or Signal Studio help for more details. Connector type: 36 pin 3M connector (part number N10236-52B2PC). The mating connector is a 3M 10136-3000 wire mount plug or 3M 10136-8000 IDC plug with a 3M 10336 shell. For Option 431 real-time custom modulation the follow pin numbers are assigned: Data input = pin 23 Data clock input = pin 29 Symbol sync input = pin 25 Burst input = pin 35 Data clock output = pin 36 Symbol sync output = pin 37 Event 1 output = pin 1 Event 2 output = pin 33
USB 2.0	The USB connector provides remote programming functions via SCPI
LAN (1000 BaseT)	The LAN connector provides the same SCPI remote programming functionality as the GPIB connector and is also used to access the internal Web server and FTP server Supports DHCP, sockets SCPI, VXI-11 SCPI, connection monitoring, dynamic hostname services, TCP keep alive LXI class C compliant Trigger response time for the immediate LAN trigger is 0.5 ms (minimum), 4 ms (maximum), 2 ms, typical; delayed/alarm triger is unknown Trigger output response time is 0.5 ms (minimum), 4 ms (maximum), 2 ms, typical
GPIB	The GPIB connector provides remote programming functionality via SCPI

Related Literature

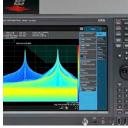
Keysight X-Series Signal Generators

MXG Configuration Guide	5990-9959EN
EXG Data Sheet	5991-0039EN
EXG Configuration Guide	5990-9958EN
X-Series Signal Generator Brochure	5990-9957EN
Signal Studio Software Brochure	5989-6448EN

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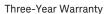
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